

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	1418470
<b>Application Number:</b>	10588029
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	4075
<b>Title of Invention:</b>	Stage drive method and stage unit, exposure apparatus, and device manufacturing method
<b>First Named Inventor/Applicant Name:</b>	Yuichi Shibasaki
<b>Customer Number:</b>	25944
<b>Filer:</b>	Joel S. Armstrong/Justin Phillips
<b>Filer Authorized By:</b>	Joel S. Armstrong
<b>Attorney Docket Number:</b>	127874
<b>Receipt Date:</b>	05-JAN-2007
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<b>Application Type:</b>	U.S. National Stage under 35 USC 371

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Foreign Reference	WO2004-019128A2.pdf	4152836	no	128

### Warnings:

<b>Information:</b>					
2	Foreign Reference	WO99-49504.pdf	2608517	no	71
<b>Warnings:</b>					
<b>Information:</b>					
3	Foreign Reference	EP1041357A1.pdf	2589699	no	36
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10	Foreign Reference	H6-124873.pdf	1484778	no	23
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11	Foreign Reference	JP04-305915.pdf	204387	no	5
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12	Foreign Reference	JP04-305917.pdf	206461	no	5
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13	Foreign Reference	JP05-062877.pdf	598766	no	14
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15	Foreign Reference	JP08-316125.pdf	2772818	no	37
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16	Foreign Reference	JP10-303114.pdf	2759774	no	59
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17	Foreign Reference	JP10-340846.pdf	2019023	no	43
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18	Foreign Reference	JP11-176727.pdf	1143629	no	16

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24	Foreign Reference	S57-153433.pdf	346505	no	9
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25	NPL Documents	LIN_Semiconductor_Foundry.pdf	649790	no	12
<b>Warnings:</b>					
<b>Information:</b>					
26	NPL Documents	OWA_etai_Immersion_lithography.pdf	636932	no	10
<b>Warnings:</b>					
<b>Information:</b>					
27	NPL Documents	OWA_etai_NGL_Workshop_2003.pdf	3194723	no	33

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28	NPL Documents	OWA_etal_Nikon_F2_Exposure_Tool_2002.pdf	1480485	no	25
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29	NPL Documents	OWA_etal_Update_on_193nm_1_38.pdf	2589421	no	38
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32	NPL Documents	SWITKES1.pdf	361449	no	4
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33	NPL Documents	SWITKES2.pdf	771930	no	7
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<b>Total Files Size (in bytes):</b>	52122690
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**New Applications Under 35 U.S.C. 111**

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.